



Thermoelectrics

MELCOR Corp.
1040 Spruce Street
Trenton, NJ 08648
Fax: (609) 393-9461
Tel: (609) 393-4178

Thermal Grease TG-001/002

Zinc Oxide Silicone Based Compound
High Thermal Conductivity
Low Thermal Resistance

IDEAL FOR:

Thermoelectric and Heatsink Interface

DESCRIPTION:

TG-001/002 is a re-workable, zinc oxide silicon based, electrically insulating and thermally conductive paste which exhibits outstanding thermal transfer in comparison to most adhesives. The non-curing nature of TG-001/002 makes it ideal as an interfacial compound for thermal transfer for thermoelectrics and heat sinks. TG-001/002 is semi-conductor grade with low ionic impurities and ultra fine thermally conductive crystallites. It has one of the lowest weight losses among thermal greases and molecularly stable for 150°C continuous exposure.

AVAILABILITY:

TG-001/002 is available in the following quantities.

Model Number	Quantity
TG-001	4 gram packet
TG-002	227 gram jar

APPLICATION PROCEDURES:

- (1) Apply a thin continuous film of grease to module hot side surface or to module area on hot side heat exchanger. A printer's ink roller works well for this.
- (2) Locate module on hot side heat exchanger, hot side down.
- (3) Gently oscillate module back and forth exerting uniform downward pressure, noting efflux of thermal compound around edges of module. Continue motion until resistance is felt.

TYPICAL PROPERTIES

Electrical Resistivity	>5x10 ¹⁴ ohm-cm
Tensile Elongation (%)	Grease
Specific Gravity	2.45
Thermal Conductivity	0.735 W/m-°C 5.1 Btu-in/hr-ft ² -°F
Linear Thermal Expansion Coeff. (ppm/°C)	Non-curing
Maximum Continuous Operation Temp. (°C)	150

CURE SCHEDULES:

Non-Curing

SHELF LIFE:

<u>Storage temperature</u>	<u>Shelf Life</u>
25 °C	5 years

"USES FOR THERMOELECTRIC COOLING ARE AS LIMITLESS AS THE IMAGINATION"